


- ① Substrate: 0.0480"±0.007" FR4/G10 or equivalent high temp material. 1/2 oz. Cu clad. SnPb plating
- ② Balls: Eutectic 63/37 SnPb.

Description: Device Converter

255 position BGA surface mount land pattern (0.05" pitch, 16 x 16 array) to 360 position BGA balls (0.05" pitch, 19x19 array) The adapter makes the conversion from a PPC 603 to a PPC 750. The adapter is 55 Ohm ± 10% controlled impedance.

 <p>© 1999 IRONWOOD ELECTRONICS, INC. PO BOX 21151 ST. PAUL, MN 55121 Tele: (651) 452-8100 www.ironwoodelectronics.com</p>	DC-BGA/BGA-750-S-B-01 Drawing	Status: Released	Scale 3:1	Rev: A
	Drawing: M. Gilk		Date: 3/12/99	
	File: DC-BGA/BGA-750-S-B-01 Dwg		Modified:	

All tolerances: ±0.005" (unless stated otherwise). Materials and specifications are subject to change without notice.